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Park et al.

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(54) **BACKLIGHT UNIT COMPRISING A PLURALITY OF SLITS FORMED ON A BOTTOM SURFACE OF AT LEAST ONE EDGE OF A BOTTOM COVER AND LIQUID CRYSTAL DISPLAY DEVICE HAVING THE SAME**

G02F 2001/133314 (2013.01); *G02F 2001/133628* (2013.01); *G02F 2201/54* (2013.01)

(58) **Field of Classification Search**
USPC 349/62-64, 69; 362/97.1-97.4, 600, 362/612
See application file for complete search history.

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(*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 477 days.

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Primary Examiner — Paul Lee

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(51) **Int. Cl.**

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G09F 13/04 (2006.01)
F21V 7/04 (2006.01)
F21V 8/00 (2006.01)
G02F 1/1333 (2006.01)

(52) **U.S. Cl.**

CPC **G02B 6/0068** (2013.01); **G02B 6/0085** (2013.01); **G02F 1/133308** (2013.01); **G02B 6/0073** (2013.01); **G02F 1/133615** (2013.01);

(57) **ABSTRACT**

A backlight unit adapted to prevent light leakage and damage of its internal components due to a thermal deformation is disclosed.

The backlight unit includes: a bottom cover with an opened upper surface; a printed-circuit-board disposed on at least one inner side surface of the bottom cover; a plurality of LEDs loaded on the printed-circuit-board; and a plurality of slits formed on at least one edge of the bottom cover opposite to the printed-circuit-board and configured to reduce thermal deformation of the bottom cover.

12 Claims, 4 Drawing Sheets

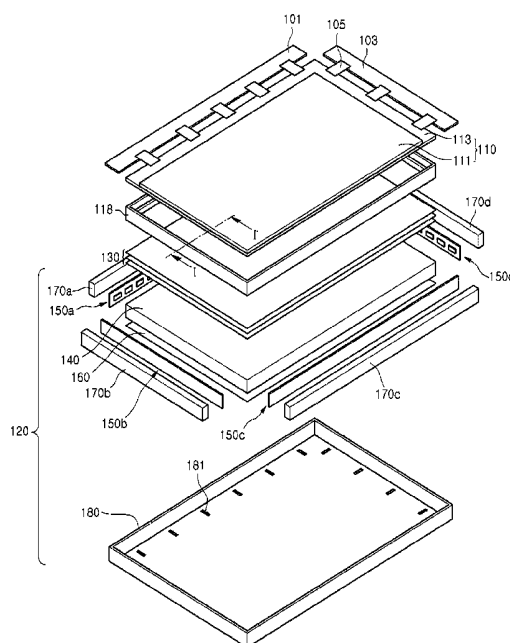


Fig. 1

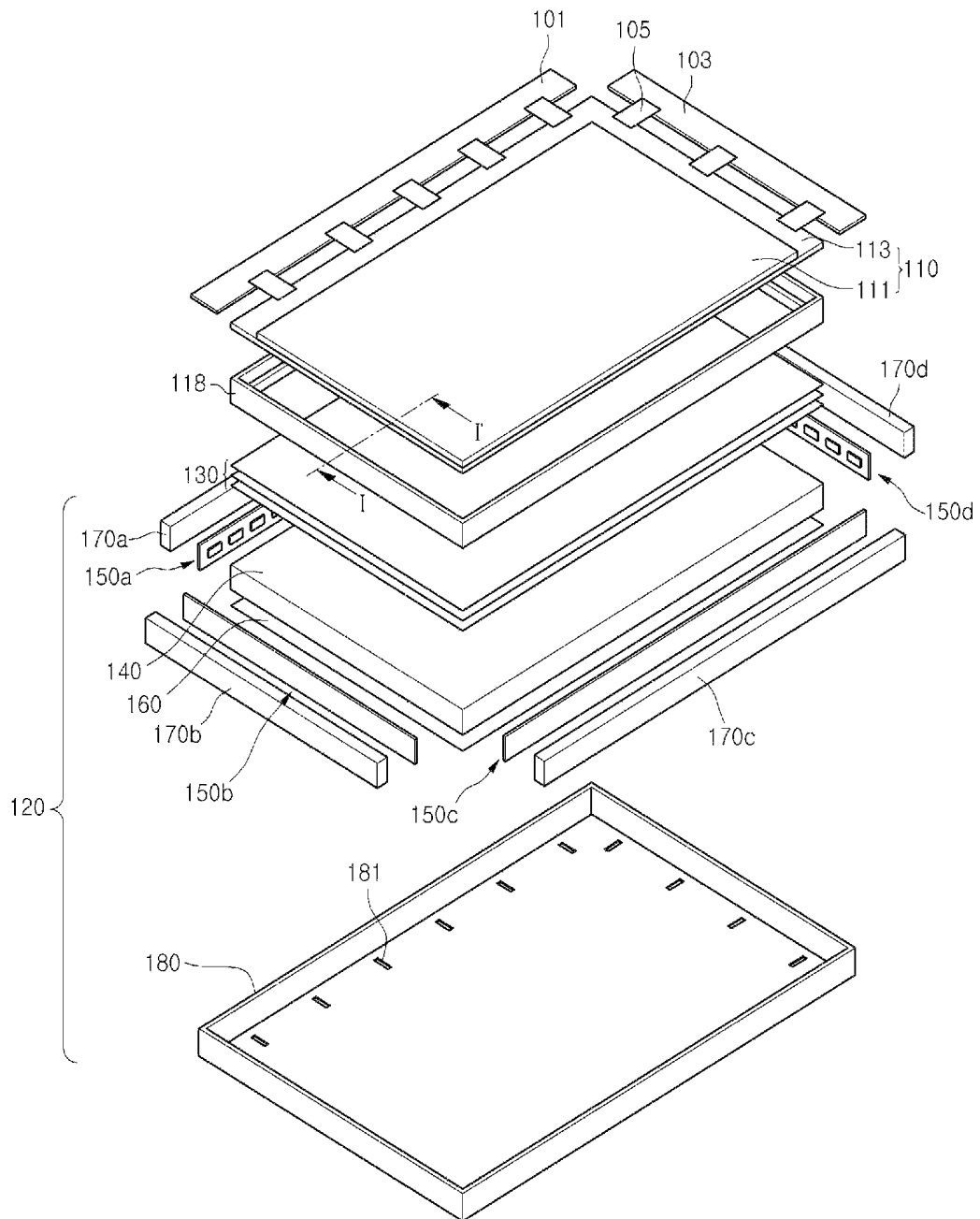


Fig. 2

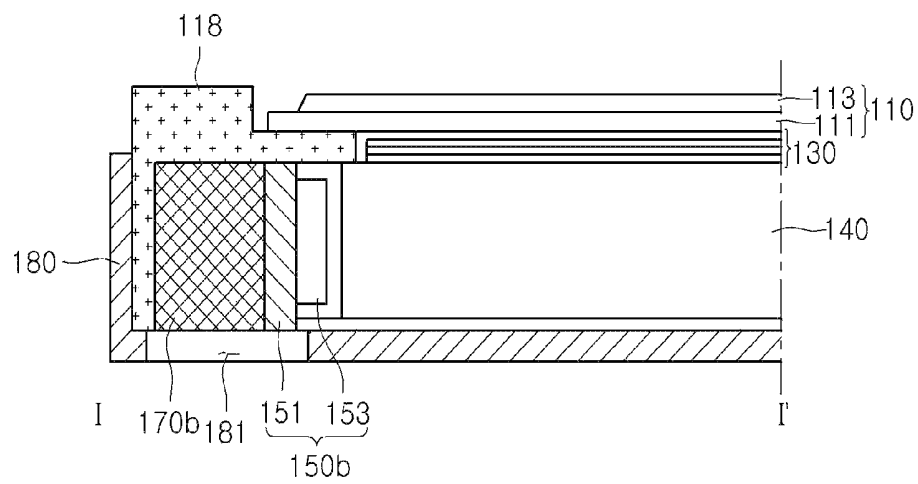


Fig. 3

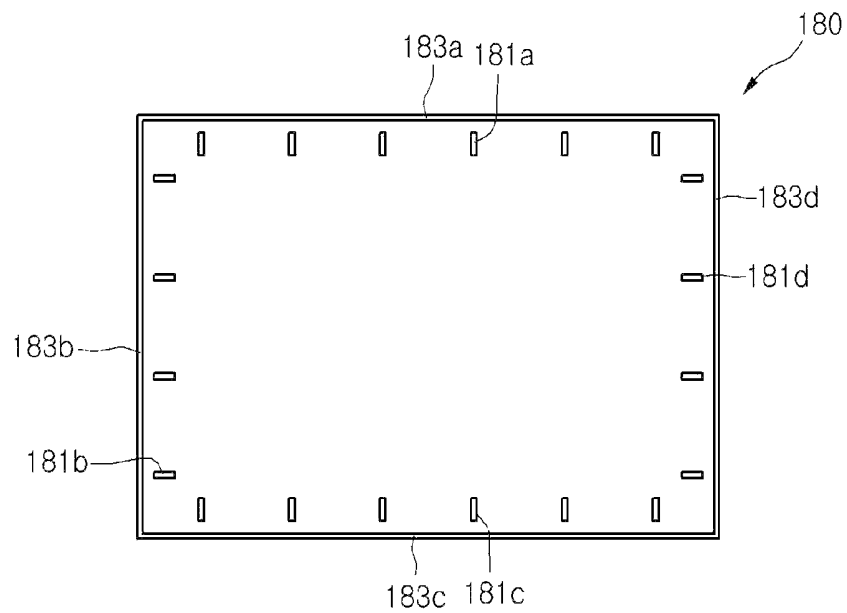


Fig. 4

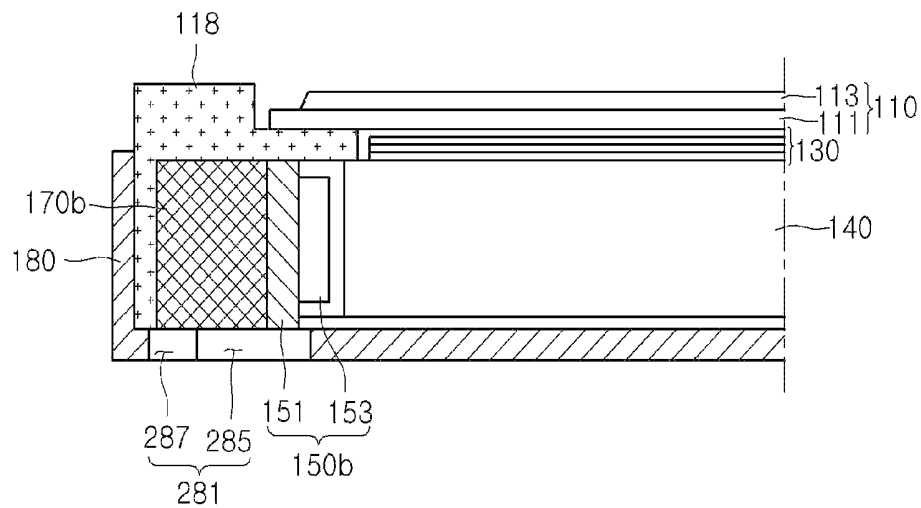


Fig. 5

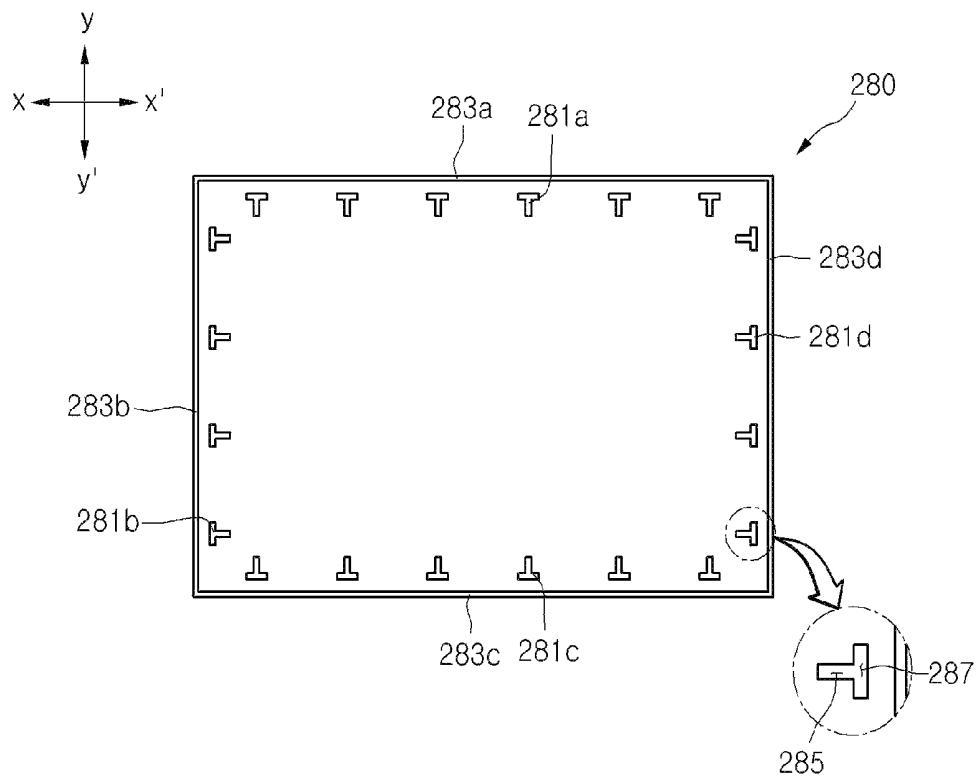


Fig. 6

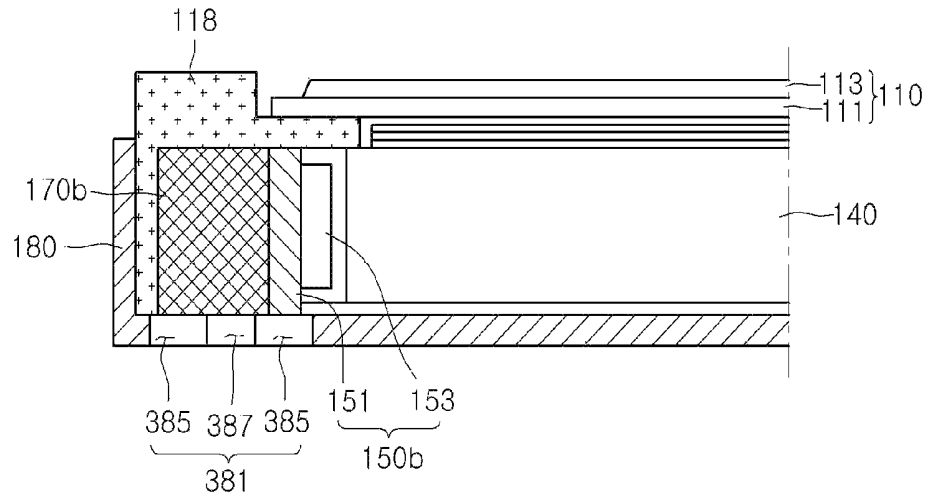
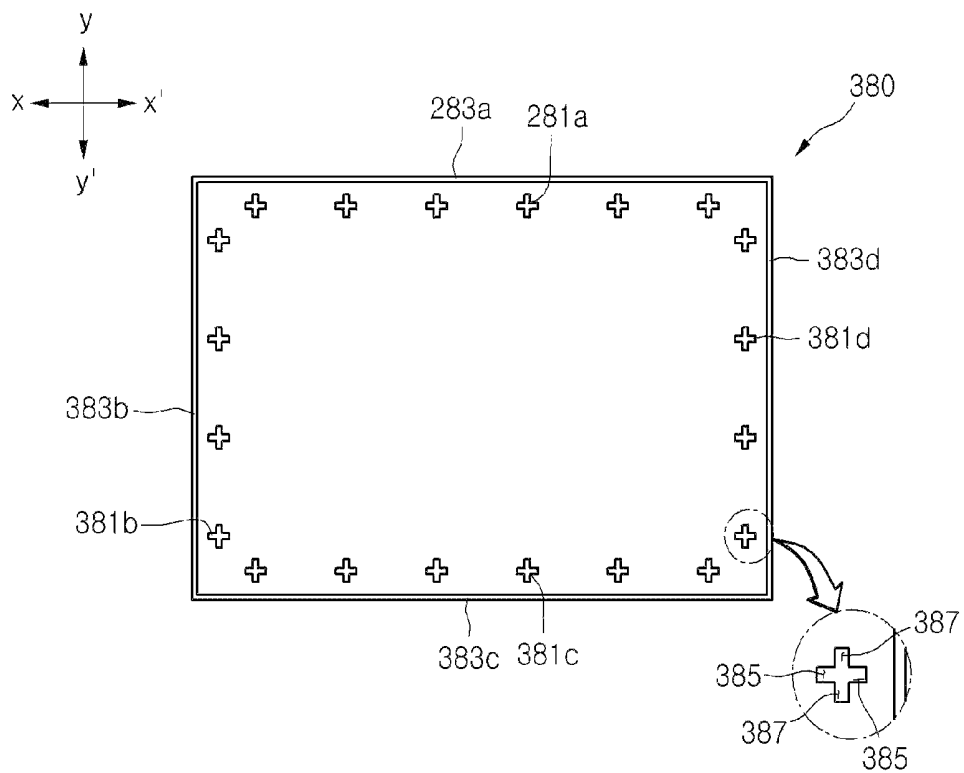


Fig. 7



**BACKLIGHT UNIT COMPRISING A
PLURALITY OF SLITS FORMED ON A
BOTTOM SURFACE OF AT LEAST ONE
EDGE OF A BOTTOM COVER AND LIQUID
CRYSTAL DISPLAY DEVICE HAVING THE
SAME**

CROSS-REFERENCE TO RELATED
APPLICATION

This application claims priority under 35 U.S.C. 119 to Korean Patent Application No. 10-2009-0072060, filed on Aug. 5, 2009, which is hereby incorporated by reference in its entirety.

BACKGROUND

1. Field of the Disclosure

This disclosure relates to a backlight unit, and more particularly to a backlight unit adapted to prevent light leakage caused by a thermal deformation, and a liquid crystal display (LCD) device with the same.

2. Description of the Related Art

Cathode ray tubes (CRTs), which correspond to one of widely used display devices, are mainly used as monitors for TVs, measuring apparatuses, or information terminals. However, the heavy weight and large size of the CRTs have been a major hindrance to the manufacturing of small, light electronic products.

To address this matter, LCD devices are gradually being used in a wide range of applications due to their advantages such as lightness, thinness, and low power consumption. Accordingly, LCD devices are being manufactured to have even larger screens, be thinner, and consume less power, in order to meet requirements of users. Such LCD devices display images by controlling the amount of light transmitted through liquid crystal.

LCD devices are not self-illuminating display devices, unlike CRTs. As such, an LCD device includes a backlight unit provided on the rear surface of an LCD panel. The backlight unit includes a separated light source providing light necessary to display an image. Actually, the backlight unit employs cold cathode fluorescent lamps (CCFLs) with electrodes encompassing both end circumferences of a lamp, external electrode fluorescent lamps (EEFLs) with electrodes inserted into both ends of a lamp, light emitting diodes (LEDs), or others, as a light source. Recently, LEDs are being mainly used as the light source of a backlight unit because they are suitable for the slimness and low power consumption of the backlight unit.

A backlight unit of the related art employing the LEDs as a light source is configured to include a box-shaped bottom cover with an opened surface and a metal printed circuit board (PCB) disposed on at least one inner side surface and loaded with a plurality of LEDs. The bottom cover is formed from a metal material. The backlight unit is further configured to include a light guide plate disposed parallel to the plurality of LEDs. The light guide plate converts spotted lights from the plurality of LEDs into a two-dimensional light and applies the two-dimensional light to a LCD panel which is disposed on it.

The LEDs are most suitable to make slimness and low power consumption of the backlight unit, as described above. On the other hand, the lifespan of LEDs can be reduced by heat generated during the driving of the LEDs.

The metal PCB disposed on the inner side surface of the bottom cover transfers heat generated in the plurality of LEDs

to the bottom cover which is formed from a metal material. Therefore, the related art backlight unit can prevent the reduction of the LED lifespan.

However, since the related art backlight unit forces the heat generated in the plurality of LEDs to be transferred to the side surface of the bottom cover, the heat is concentrated to the side surface of the bottom cover. As such, the bottom cover is deformed by the heats concentrated to its side surface. This results from the fact that the bottom cover of a metal material easily expands and contracts with heat.

More specifically, the concentrated heat forces the side surface of the bottom cover to be thermally deformed to have a bent shape. Due to this, components within the bottom cover can be damaged. Also, the bent side surface of the bottom cover causes light to be leaked from the edge of the bottom cover, so that brightness of the backlight unit (and the LCD device) is deteriorated. Consequently, the thermal deformation of the bottom cover can deteriorate displaying quality of the LCD device.

BRIEF SUMMARY

Accordingly, the present embodiments are directed to a backlight unit that substantially obviates one or more of problems due to the limitations and disadvantages of the related art, and an LCD device with the same.

An object of the present embodiments is to provide a backlight unit that is adapted to prevent light leakage and damage of its internal components due to a thermal deformation.

Another object of the present embodiments is to provide an LCD device that is adapted to improve displaying quality.

Additional features and advantages of the embodiments will be set forth in the description which follows, and in part will be apparent from the description, or may be learned by practice of the embodiments. The advantages of the embodiments will be realized and attained by the structure particularly pointed out in the written description and claims hereof as well as the appended drawings.

According to one general aspect of the present embodiment, a backlight unit includes: a bottom cover with an opened upper surface; a printed-circuit-board disposed on at least one inner side surface of the bottom cover; a plurality of LEDs loaded on the printed-circuit-board; and a plurality of slits formed on at least one edge of the bottom cover opposite to the printed-circuit-board and configured to reduce thermal deformation of the bottom cover.

An LCD device according to another general aspect of the present embodiment, includes: a liquid crystal display panel; a bottom cover configured to include an opened upper surface and disposed under the liquid crystal display panel; a printed-circuit-board disposed on at least one inner side surface of the bottom cover; a plurality of LEDs loaded on the printed-circuit-board; and a plurality of slits formed on at least one edge of the bottom cover opposite to the printed-circuit-board and configured to reduce thermal deformation of the bottom cover.

Other systems, methods, features and advantages will be, or will become, apparent to one with skill in the art upon examination of the following figures and detailed description. It is intended that all such additional systems, methods, features and advantages be included within this description, be within the scope of the invention, and be protected by the following claims. Nothing in this section should be taken as a limitation on those claims. Further aspects and advantages are discussed below in conjunction with the embodiments. It is to be understood that both the foregoing general description and the following detailed description of the present disclosure

are exemplary and explanatory and are intended to provide further explanation of the disclosure as claimed.

BRIEF DESCRIPTION OF THE DRAWINGS

The accompanying drawings, which are included to provide a further understanding of the embodiments and are incorporated in and constitute a part of this application, illustrate embodiment(s) of the invention and together with the description serve to explain the disclosure. In the drawings:

FIG. 1 is a disassembled perspective view showing an LCD device according to an embodiment of the present disclosure;

FIG. 2 is a cross-sectional view showing the LCD device taken along a line I-I' in FIG. 1;

FIG. 3 is a planar view showing a bottom cover according to an embodiment of the present disclosure;

FIG. 4 is a cross-sectional view showing an LCD device according to another embodiment of the present disclosure;

FIG. 5 is a planar view showing a bottom cover according to another embodiment of the present disclosure;

FIG. 6 is a cross-sectional view showing an LCD device according to still another embodiment of the present disclosure; and

FIG. 7 is a planar view showing a bottom cover according to still another embodiment of the present disclosure.

DETAILED DESCRIPTION

Reference will now be made in detail to the embodiments of the present disclosure, examples of which are illustrated in the accompanying drawings. These embodiments introduced hereinafter are provided as examples in order to convey their spirits to the ordinary skilled person in the art. Therefore, these embodiments might be embodied in a different shape, so are not limited to these embodiments described here. Also, the size and thickness of the device might be expressed to be exaggerated for the sake of convenience in the drawings. Wherever possible, the same reference numbers will be used throughout this disclosure including the drawings to refer to the same or like parts.

FIG. 1 is a disassembled perspective view showing an LCD device according to an embodiment of the present disclosure. FIG. 2 is a cross-sectional view showing the LCD device taken along a line I-I' in FIG. 1. FIG. 3 is a planar view showing a bottom cover according to an embodiment of the present disclosure.

Referring to FIGS. 1 to 3, an LCD device according to an embodiment of the present disclosure includes an LCD panel 110 configured to display images, a backlight unit 120 disposed under the LCD panel 110 and configured to apply light to the LCD panel 110, and a panel guider 118 configured to support edges of the rear surface of the LCD panel 110. The panel guider 118 is combined with the backlight unit 120.

Although it is not shown in detail in the drawings, the LCD panel 110 includes a thin film transistor substrate 113 and a color filter substrate 111 disposed opposite each other and combined to uniformly maintain a cell gap between them, as well as a liquid crystal layer (not shown) interposed between the two substrates 111 and 113. On the thin film transistor substrate 113, a plurality of gate lines are formed, a plurality of data lines are formed to cross the plurality of gate lines, and a plurality of transistors TFT are formed at the intersections of the plurality of gate lines and the plurality of data lines. The color filter substrate 111 includes color filters which are formed opposite pixels, respectively.

The LCD device further includes a gate driving printed-circuit-board (PCB) 103 and a data driving PCB 101 disposed

by the sides of the LCD panel 110. The gate driving PCB 103 sequentially applies a scan signal to the gate lines on the LCD panel 110. The data driving PCB 101 applies data signals to the data lines on the LCD panel 110. To this end, the gate and data driving PCBs 103 and 101 are electrically connected to the LCD panel 110 by means of COFs (chip on film) 105. The COFs 105 can be replaced with tape carrier packages (TCPs).

The backlight unit 120 includes a box-shaped bottom cover 180 with an opened upper surface, first to fourth light source modules 150a to 150d arranged on inner side surfaces of the bottom cover 180, a light guide plate 140 disposed between the first to fourth light source modules 150a to 150d, optical sheets 130 disposed on the light guide plate 140, and a reflection sheet 160 disposed under the light guide plate 140. The light guide plate 140 is configured to convert spotted incident lights from the first through fourth light source modules 150a through 150d into a two-dimensional light. The optical sheets 130 are configured to diffuse and converge the two-dimensional light entered from the light guide plate 140. The reflection sheet 160 reflects light progressing downward from the light guide plate 140 toward the optical sheets 130. The first through fourth light source modules 150a through 150d are configured to each include a metal PCB 151 and a plurality of LEDs 153 loaded on the metal PCB.

The backlight unit 120 further includes first to fourth heat radiation plates 170a to 170d each disposed between the first to fourth light source modules 150a to 150d and the inner side surfaces of the bottom cover 180. The first through fourth heat radiation plates 170a through 170d are used to rapidly transfer heat generated in the first through fourth light source modules 150a through 150d toward the bottom cover 180.

The box-shaped bottom cover 180 with the opened upper surface is configured to include a bottom surface and first to fourth side surfaces 183a to 183d. Also, the bottom cover 180 is further configured to include a plurality of slits formed along lines which are separated by a fixed distance from the first to fourth side surfaces 183a to 183d. In other words, the plurality of slits are formed at a fixed interval along edges of the bottom surface of the bottom cover 180.

The plurality of slits 181 include first to fourth slits 181a to 181d with a bar shape. The first slits 181a are formed on an edge of the bottom surface adjacent to the first side surface 183a. The second slits 181b are formed on another edge of the bottom surface adjacent to the second side surface 183b. The third slits 181c are formed on still another edge of the bottom surface adjacent to the third side surface 183c. The fourth slits 181d are formed on further still another edge of the bottom surface adjacent to the fourth side surface 183d. Each of the first to fourth slits 181a to 181d is formed to extend perpendicularly to the longitude direction of the respective side surface 183a to 183d.

Also, the plurality of slits 181 with the first to fourth slits 181a to 181d are formed on the edge region of the bottom surface opposite to the first through fourth light source modules 150a through 150d and the first through fourth heat radiation plates 170a through 170d. As such, heat, which is transferred from the first through fourth light source modules 150a through 150d via the first through fourth heat radiation plates 170a through 170d toward the bottom cover 180 (more specifically, the first through fourth side surfaces 183a through 183d), can be partially bypassed to the exterior of the bottom cover 180 via the plurality of slits 181. In other words, the plurality of slits 181 eases the local concentration of heat in a region of the bottom cover 180 on which the first through fourth light source modules 150a through 150d and the first through fourth heat radiation plates 170a through 170d are

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arranged. Therefore, thermal deformation of the bottom cover **180** caused by the local concentration of heat can be minimized.

Although the LCD device according to an embodiment of the present disclosure is described to have the configuration that the plurality of slits **181** are separated by a fixed distance from the side surfaces **183a** through **183d** of the bottom cover **180**, it is not limited to this. For example, the plurality of slits **181** can be formed opposite the lower surfaces of the first through fourth light source modules **150a** through **150d** and first through fourth heat radiation plates **170a** through **170d**, as well as the side surfaces of the first through fourth heat radiation plates **170a** through **170d**. In other words, the plurality of slits **181** can be positionally changed in the formation.

Also, the LCD device according to an embodiment of the present disclosure is disclosed to include the first through fourth light source modules **150a** through **150d** disposed on all the inner side surfaces of the bottom cover **180**. However, the LCD device can be configured to include at least one light source module disposed on at least one inner side surface of the bottom cover **180** according to design specifications.

Moreover, the plurality of slits **181** provides extra space making it possible for the bottom cover **180** to expand and contract with heat. Therefore, the thermal deformation of the bottom cover **180** can be prevented.

In this manner, the LCD device according to an embodiment of the present disclosure can prevent the thermal deformation of the bottom cover **180** caused by the heat which are generated in the first through fourth light source modules **150a** through **150d** and concentrated to the side surfaces **183a** through **183d** of the bottom cover **180**. As such, damage of components within the LCD device can be prevented.

Furthermore, the LCD device according to an embodiment of the present disclosure can prevent the brightness deterioration derived from the thermal deformation of the bottom cover **180**. Therefore, the LCD device can improve displaying quality.

FIG. **4** is a cross-sectional view showing an LCD device according to another embodiment of the present disclosure. FIG. **5** is a planar view showing a bottom cover according to another embodiment of the present disclosure.

The LCD device of another embodiment in FIGS. **4** and **5** has the same configuration as that according to an embodiment of the present disclosure shown in FIGS. **1** and **3**, with the exception of a bottom cover **280**. As such, the rest of the LCD device according to another embodiment without the bottom cover **280** will be referred to with the same numbers as those according to that embodiment of FIGS. **1** to **3**. Moreover, the detailed description for the rest of the LCD device of another embodiment without the bottom cover **280** will be omitted.

A bottom cover **280** according to another embodiment of the present disclosure is formed in a box-shape with the opened upper surface. The bottom cover **280** is configured to include a bottom surface and first to fourth side surfaces **283a** to **283d**. Also, the bottom cover **280** is further configured to include a plurality of slits **281** formed along lines which are separated by a fixed distance from the first to fourth side surfaces **283a** to **283d**. In other words, the plurality of slits **281** are formed at a fixed interval along edges of the bottom surface of the bottom cover **280**.

The plurality of slits **281** is formed on the bottom surface opposite to the first through fourth light source modules **150a** through **150d** and the first through fourth heat radiation plate **170a** through **170d**. Also, the plurality of slits **281** includes first to fourth slits **281a** to **281d** with a "T" shape. The first

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slits **281a** are formed on an edge of the bottom surface adjacent to the first side surface **283a**. The second slits **281b** are formed on another edge of the bottom surface adjacent to the second side surface **283b**. The third slits **281c** are formed on still another edge of the bottom surface adjacent to the third side surface **283c**. The fourth slits **281d** are formed on further still another edge of the bottom surface adjacent to the fourth side surface **283d**.

Each of the first through fourth slits **281a** through **281d** is formed to have a first hole pattern **287** parallel to the respective side surface **283a** through **283d**, and a second hole pattern **285** perpendicular to the first hole pattern **287**. The second hole pattern **285** is formed to extend from an middle portion of the first hole pattern toward an inner side of the bottom surface. Consequently, the plurality of slits **281** is formed all in a "T" shape.

The first hole pattern **287** is used to prevent a thermal deformation of the bottom cover **280** in a direction parallel to the respective side surface **283** of the bottom cover **280**. The second hole pattern **285** is used to prevent another thermal deformation of the bottom cover **280** in another direction perpendicular to the respective side surface **283** of the bottom cover **280**. For example, the first hole pattern **287** included in the fourth slit **281d** prevents a thermal deformation of the bottom cover **280** in a first direction of x-x', and the second hole pattern **285** included in the fourth slit **281** prevents another thermal deformation of the bottom cover **280** in a second direction of y-y'.

Consequently, the plurality of slits **281** provides extra space making it possible for the bottom cover **280** to expand and contract with heat. As such, the thermal deformation of the bottom cover **280** in the first and second directions of x-x' and y-y' can be prevented.

As described above, the LCD device according to another embodiment of the present disclosure can prevent the thermal deformation of the bottom cover **280** caused by the heat which is generated in the first through fourth light source modules **150a** through **150d** and concentrated to the side surfaces **283** of the bottom cover **280**. As such, damage of components within the LCD device can be prevented.

Furthermore, the LCD device according to another embodiment of the present disclosure can prevent the brightness deterioration derived from the thermal deformation of the bottom cover **180**. Therefore, the LCD device can improve display quality.

FIG. **6** is a cross-sectional view showing an LCD device according to still an embodiment of the present disclosure. FIG. **7** is a planar view showing a bottom cover according to still another embodiment of the present disclosure.

The LCD device of still another embodiment in FIGS. **6** and **7** has the same configuration as that according to an embodiment of the present disclosure shown in FIGS. **1** and **3**, with the exception of a bottom cover **380**. As such, the rest of the LCD device according to still another embodiment without the bottom cover **380** will be referred to with the same numbers as those according to that embodiment of FIGS. **1** to **3**. Moreover, the detailed description for the rest of the LCD device of still another embodiment without the bottom cover **380** will be omitted.

A bottom cover **380** according to still another embodiment of the present disclosure is formed in a box-shape with an opened upper surface. The bottom cover **380** is configured to include a bottom surface and first to fourth side surfaces **383a** to **383d**. Also, the bottom cover **380** is further configured to include a plurality of slits **381** formed along lines which are separated by a fixed distance from the first to fourth side surfaces **383a** to **383d**. In other words, the plurality of slits

381 are formed at a fixed interval along edges of the bottom surface of the bottom cover **380**.

The plurality of slits **381** is formed on the bottom plate opposite to the first through fourth light source modules (**150a** through **150d** in FIG. 1) and the first through fourth heat radiation plate (**170a** through **170d** in FIG. 1). Also, the plurality of slits **381** includes first to fourth slits **381a** to **381d** with a shape of “+”. The first slits **381a** are formed on an edge of the bottom surface adjacent to the first side surface **383a**. The second slits **381b** are formed on another edge of the bottom surface adjacent to the second side surface **383b**. The third slits **381c** are formed on still another edge of the bottom surface adjacent to the third side surface **383c**. The fourth slits **381d** are formed on further still another edge of the bottom surface adjacent to the fourth side surface **383d**.

Each of the first through fourth slits **381a** through **381d** is formed to have a first hole pattern **387** parallel to a longitude direction of the respective side surface **383**, and a second hole pattern **385** perpendicular to the first hole pattern **387**. The first and second hole patterns **387** and **385** are formed to cross each other, so that their middle portions are overlapped with each other. Consequently, the plurality of slits **381** is formed all in the shape of “+”.

The first hole pattern **387** is used to prevent a thermal deformation of the bottom cover **380** in a direction parallel to the respective side surface **383** of the bottom cover **380**. The second hole pattern **385** is used to prevent another thermal deformation of the bottom cover **380** in another direction perpendicular to the respective side surface **383** of the bottom cover **380**. For example, the first hole pattern **387** included in the fourth slit **381d** prevents a thermal deformation of the bottom cover **380** in a first direction of x-x', and the second hole pattern **385** included in the fourth slit **381d** prevents another thermal deformation of the bottom cover **380** in a second direction of y-y'.

Consequently, the plurality of slits **381** provides extra space making it possible for the bottom cover **380** to expand and contract with heat. As such, the thermal deformation of the bottom cover **380** in the first and second directions of x-x' and y-y' can be prevented.

In this way, the LCD device according to still another embodiment of the present disclosure can prevent the thermal deformation of the bottom cover **380** caused by the heat which is generated in the first through fourth light source modules **150a** through **150d** and concentrated to the side surfaces of the bottom cover **380**. As such, damage of components within the LCD device can be prevented.

Moreover, the LCD device according to still another embodiment of the present disclosure can prevent the brightness deterioration derived from the thermal deformation of the bottom cover **380**. Therefore, the LCD device can improve display quality.

Although the present disclosure has been limitedly explained regarding only the embodiments described above, it should be understood by the ordinary skilled person in the art that the present disclosure is not limited to these embodiments, but rather that various changes or modifications thereof are possible without departing from the spirit of the present disclosure. Accordingly, the scope of the present disclosure shall be determined only by the appended claims and their equivalents.

What is claimed is:

1. A backlight unit comprising:

a bottom cover with an opened upper surface;

a printed-circuit-board disposed on at least one inner side surface of the bottom cover;

a plurality of LEDs loaded on the printed-circuit-board;

a heat radiation plate between the printed-circuit-board and the at least one inner side surface of the bottom cover; and

a plurality of slits formed on at least one edge of the bottom cover opposite to the printed-circuit-board and configured to reduce thermal deformation of the bottom cover, wherein the printed-circuit-board is formed to include a metal material,

wherein the heat radiation plate is exposed to an exterior of the bottom cover,

wherein the bottom cover has a bottom surface and the first to fourth side surfaces, and

wherein the plurality of slits is formed on the bottom surface of the at least one edge of the bottom cover.

2. The backlight unit claimed as claim 1, wherein the plurality of slits is formed to extend perpendicularly to a longitude direction of the side surface of the bottom cover.

3. The backlight unit claimed as claim 1, wherein, the slit is configured to include a first hole pattern formed in a first direction which corresponds to a longitude direction of the side surface of the bottom cover, and a second hole pattern formed in a second direction perpendicular to the first direction.

4. The backlight unit claimed as claim 3, wherein the slit is formed in a “T” shape.

5. The backlight unit claimed as claim 3, wherein the slit is formed in a shape of “+”.

6. The backlight unit claimed as claim 1, wherein the printed-circuit-board is disposed on all the inner side surfaces of the bottom cover.

7. A liquid crystal display device comprising:

a liquid crystal display panel;

a bottom cover configured to include an opened upper surface and disposed under the liquid crystal display panel;

a printed-circuit-board disposed on at least one inner side surface of the bottom cover;

a plurality of LEDs loaded on the printed-circuit-board;

a heat radiation plate between the printed-circuit-board and the at least one inner side surface of the bottom cover; and

a plurality of slits formed on at least one edge of the bottom cover opposite to the printed-circuit-board and configured to reduce thermal deformation of the bottom cover, wherein the printed-circuit-board is formed to include a metal material, and

wherein the heat radiation plate is exposed to an exterior of the bottom cover,

wherein the bottom cover has a bottom surface and the first to fourth side surfaces, and

wherein the plurality of slits is formed on the bottom surface of the at least one edge of the bottom cover.

8. The liquid crystal display device claimed as claim 7, wherein the plurality of slits is formed to extend perpendicularly to the side direction of the side surface of the bottom cover.

9. The liquid crystal display device claimed as claim 7, wherein, the slit is configured to include a first hole pattern formed in a first direction which corresponds to a longitude direction of the side surface of the bottom cover, and a second hole pattern formed in a second direction perpendicular to the first direction.

10. The liquid crystal display device claimed as claim 9, wherein the slit is formed in a “T” shape.

11. The liquid crystal display device claimed as claim 9, wherein the slit is formed in a shape of “+”.

12. The liquid crystal display device claimed as claim 7, wherein the printed-circuit-board is disposed on all the inner side surfaces of the bottom cover.

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专利名称(译)	背光单元包括形成在底盖的至少一个边缘的底表面上的多个狭缝和具有该背光的液晶显示装置		
公开(公告)号	US9019443	公开(公告)日	2015-04-28
申请号	US12/850183	申请日	2010-08-04
[标]申请(专利权)人(译)	咀香园SOO DAN KYUNG SIK		
申请(专利权)人(译)	咀香园SOO DAN KYUNG SIK		
当前申请(专利权)人(译)	LG DISPLAY CO. , LTD.		
[标]发明人	PARK HEONG SOO DAN KYUNG SIK		
发明人	PARK, HEONG SOO DAN, KYUNG SIK		
IPC分类号	G02F1/1335 G09F13/04 F21V7/04 F21V8/00 G02F1/1333		
CPC分类号	G02B6/0068 G02B6/0085 G02F1/133308 G02B6/0073 G02F1/133615 G02F2001/133314 G02F2001/133628 G02F2201/54		
审查员(译)	LEE , PAUL		
优先权	1020090072060 2009-08-05 KR		
其他公开文献	US20110032447A1		
外部链接	Espacenet USPTO		

摘要(译)

公开了一种背光单元，其适于防止由于热变形导致的光泄漏和其内部部件的损坏。背光单元包括：底盖，其具有敞开的上表面；印刷电路板，设置在底盖的至少一个内侧表面上；多个LED装在印刷电路板上；多个狭缝形成在底盖的与印刷电路板相对的至少一个边缘上，并构造造成减少底盖的热变形。

